Yuan Yao

✓ yuanyao.ac@gmail.com | ✓ yaoyuan9921@mails.jlu.edu.cn | ✓ (+86) 13338882699 | % yuan-yao.me

EDUCATION

Jilin University, China 2021.9-now

Bachelor of Engineering, School of Mechanical and Aerospace Engineering Overall score: 90.62/100, rank within top 5%

Tohoku University, Japan

2023.10-2024.8

Exchange Student, Department of Robotics Converted to 93.6/100, no rank and GPA

RESEARCH EXPERIENCES

Exploration of Film Separation Technique by Internal Laser Damage Advised by Prof. Shuji Tanaka and Prof. Andrea Vergara

2023.10-2024.8

MEMS lab, Tohoku University

- •A two-dimensional laser **stealth dicing** method for **low-stress separation of silicon-based thin films** is implemented, verifying its feasibility in the **transfer of flexible piezoelectric devices**. The output was presented at MNC2024 and expanded to the a journal paper (expected).
- Experienced in cleanroom workflows and equipment operation, including: Mask design/fabrication, Photolithography, DRIE, PVD/CVD, Dicing, Laser systems, and OM/SEM/IR microscopy. More

Ultrasonic Vibration-assisted Scratch Testing Platform: Design and Study Advised by Prof. Hu Huang

2022.9-2024.4

Huang lab, Jilin University

- Design and verify the thread-V groove composite structure to ensure effective vibration transmission; match the system's resonance frequency with the ultrasonic transducer working frequency through Abaqus **modal simulation**.
- Fills the gap for instruments that can perform scratch testing under ultrasonic vibration.

 National Undergraduate Training Program for Innovation and Entrepreneurship, National Excellent Conclusion.

ACADEMIC ACHIEVEMENT

Derived a patent and a journal paper. More

- A paper submitted (conference extended): **Yao, Y.**, Vergara, A., Tang, Z. & Tanaka, S. Feasibility study of layer separation using 2D patterned internal laser damage in silicon. **IEEJ Transactions on Electrical and Electronic Engineering**
- •Oral presentation on the 37th International Microprocesses and Nanotechnology Conference (MNC 2024), Kyoto: The Japan Society of Applied Physics, Nov. 2024, 15D-2-3. <u>Slide Abstract</u>
- Huang, Y.; Wu, H.; Yao, Y.; Zhao, H.; Huang, H. An Ultrasonic Vibration Scratch Tester for Studying the Scratch Characteristics of Materials under Ultrasonic Vibration Contact Status. *Actuators* 2024, 13, 262. https://doi.org/10.3390/act13070262
- •H. Huang, Y. Yao, Y. Huang, and H. Wu, "An ultrasonic vibration device for vibration-assisted scratch testing," Chinese Patent CN 220649966U, Mar. 22, 2024. Patent

SKILLS

- Languages: Native Mandarin; Fluent English including IELTs: 7.0 and GRE: 320; Basic Japanese
- Professional Software: Proficient: Solidworks, AutoCAD; Intermediate: Catia, Ansys, Abaqus, Comsol, Origin
- Programming Skills: Python, Matlab, C#, Julia, LATEX

AWARDS AND HONORS

National second prize- National University Students' Advanced Drawing Technology and Product Information

- Modeling Innovation Competition
 - ♦ Advanced Engineering drawing; Proficient in CAD software; Teaching of the competition More

2022.8

Provincial first prize - China College Students Engineering Practice and Innovation Competition

♦ Led the design and manufacture of a new energy mini-vehicle More

2023.11

• Exchange student scholarship - Japan Student Services Organization

2023.10-2024.8

• First-class scholarship; Excellent student - Jilin University

2023.11/2022.11

• Excellent student leader - School of Mechanical and Aerospace Engineering, Jilin University

2022.11